



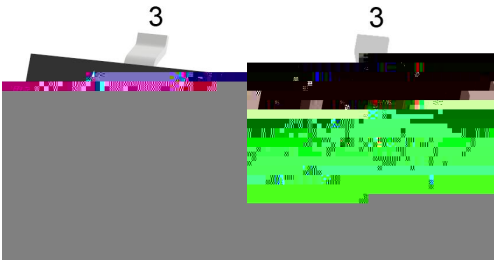
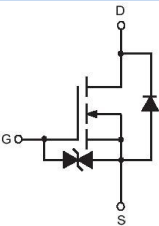
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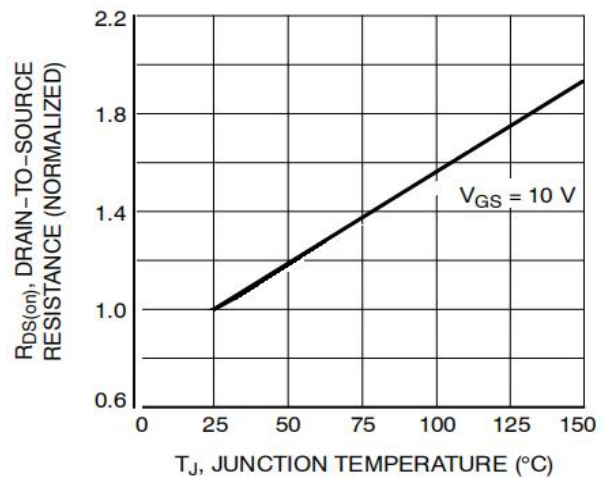
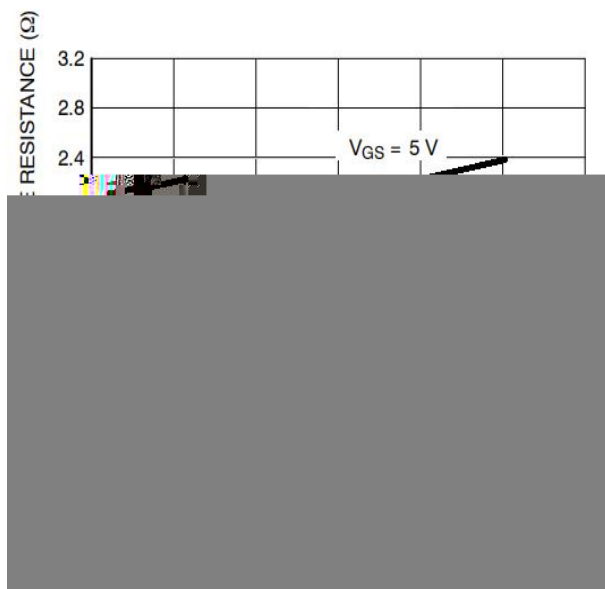
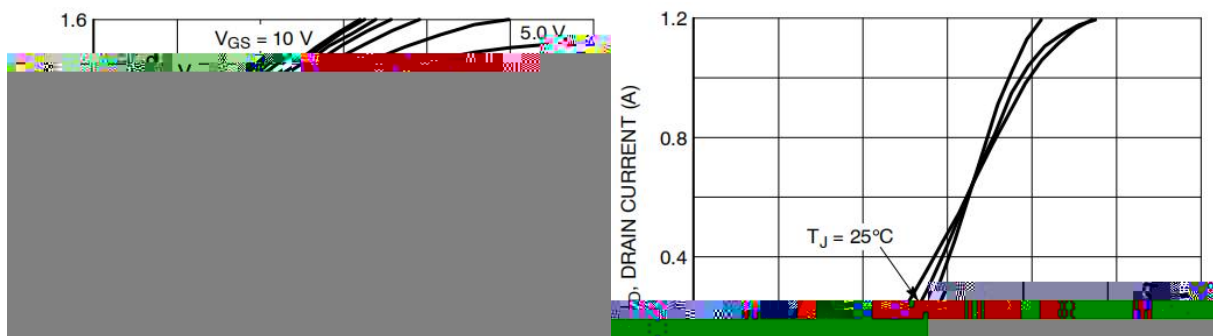
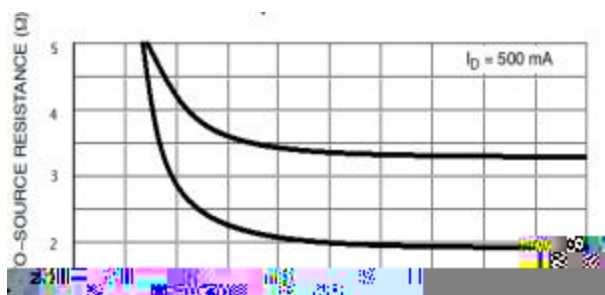


Figure 4 On-Resistance Variation with Temperature



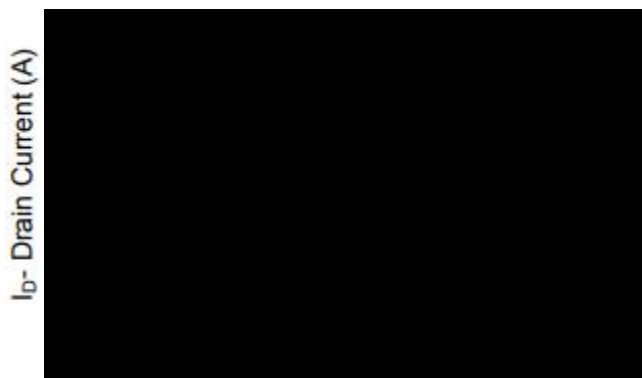
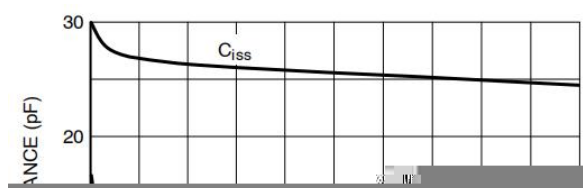
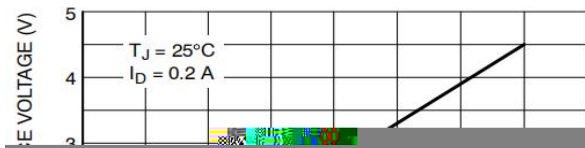
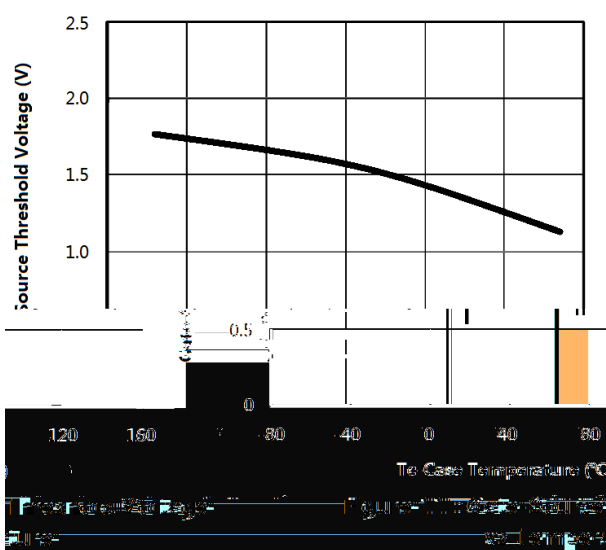
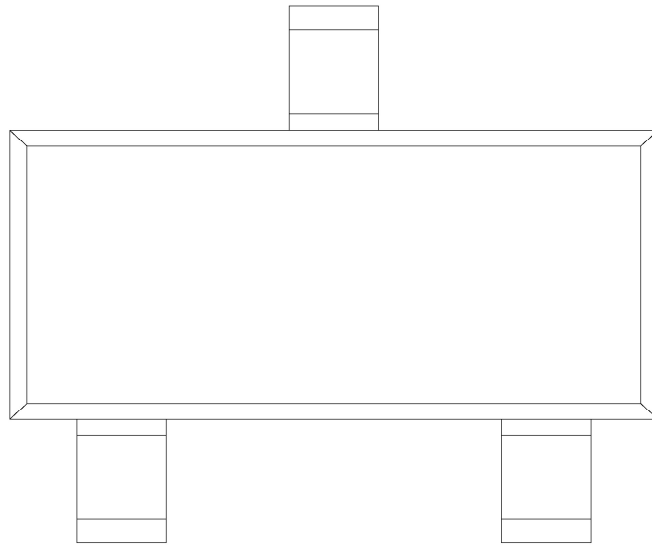


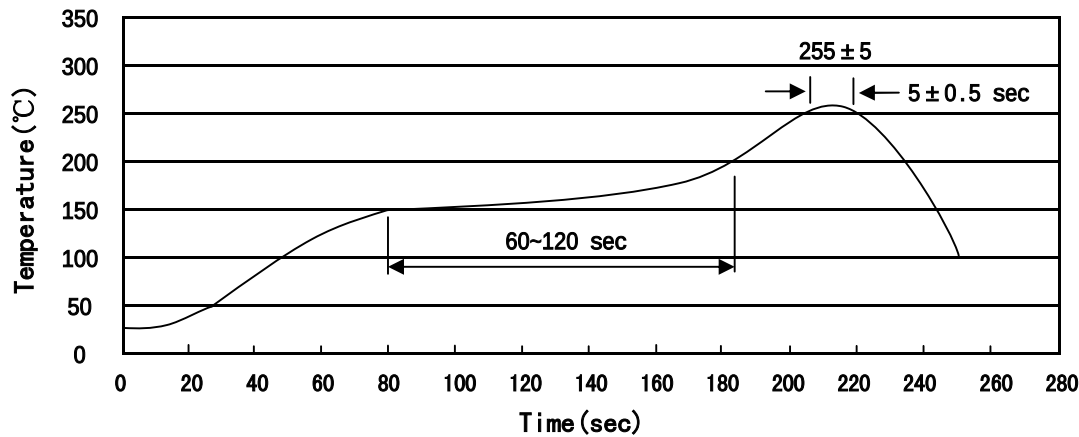
Figure 9 : Safe Operation Area







Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 、预热温度 ~ °C，时间 ~ °C
- 、峰值温度 ± °C，时间持续为 ± °C
- 、焊接制程冷却速度为 ~ °C

温度： ± °C 时间： ± °C

卷盘包装

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7" ×8	180×120×180	390×385×205